# **LCC Converter Small Signal Modeling**

**Brent McDonald** 



# Introduction

 Demanding efficiency requirements are driving engineers to the LLC resonant converter

80 PLUS Certification	115 V Internal Non-Redundant			230 V Internal Redundant				
% of Rated Load	10%	20%	50%	100%	10%	20%	50%	100%
80 PLUS	_	80%	80%	80%		Ν	I/A	
80 PLUS Bronze	_	82%	85%	82%	_	81%	85%	81%
80 PLUS Silver	_	85%	88%	85%	_	85%	89%	85%
80 PLUS Gold	_	87%	90%	87%	_	88%	92%	88%
80 PLUS Platinum	_	90%	92%	89%	_	90%	94%	91%
80 PLUS Titanium	_	_	_	_	90%	94%	96%	91%

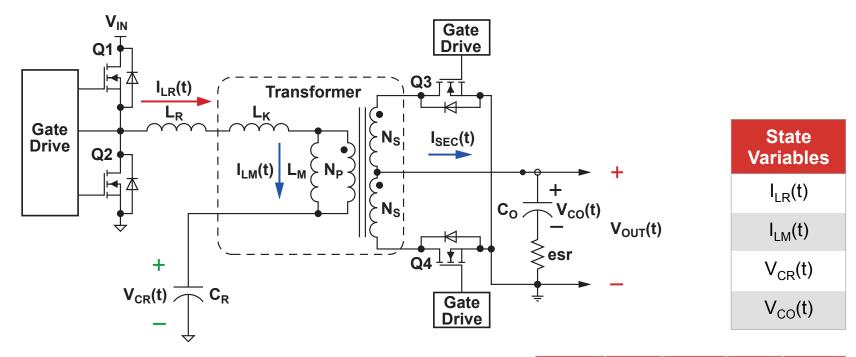
Courtesy: http://www.plugloadsolutions.com/80PlusPowerSupplies.aspx

• How do we identify and verify a robust set of compensation values for this converter?

# **Discussion Outline**

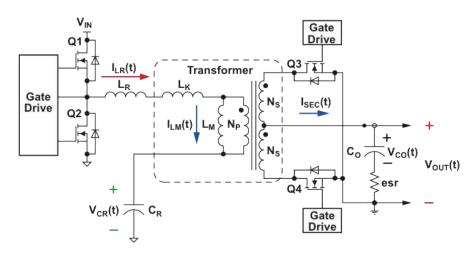
- LLC Converter
- Modeling Process
- Case Study
- Tools
- Practical Limitations
- Conclusion

# **Operating States**



State	Q1	Q2	Q3	Q4
1	ON	OFF	OFF	ON
2	ON	OFF	ON	OFF
3	ON	OFF	OFF	OFF
4	OFF	ON	OFF	ON
5	OFF	ON	ON	OFF
6	OFF	ON	OFF	OFF

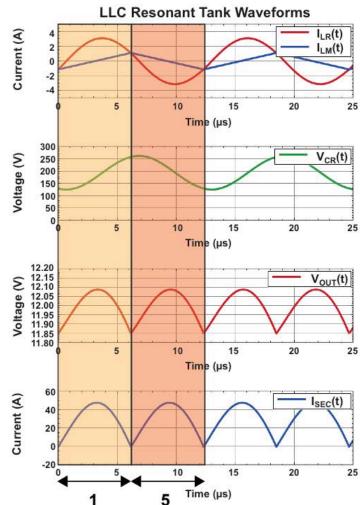
#### **Mode: Resonance**



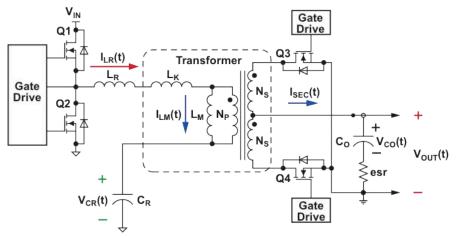
Mode State Sequence:  $1 \rightarrow 5$ 

State	Q1	Q2	Q3	Q4
1	ON	OFF	OFF	ON
2	ON	OFF	ON	OFF
3	ON	OFF	OFF	OFF
4	OFF	ON	OFF	ON
5	OFF	ON	ON	OFF
6	OFF	ON	OFF	OFF

V<sub>IN</sub> = 387.6 V

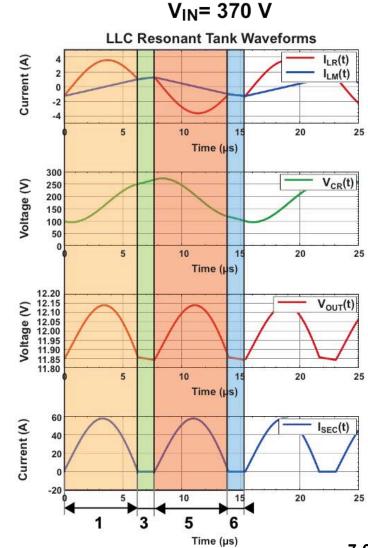


#### **Mode: Below Resonance**

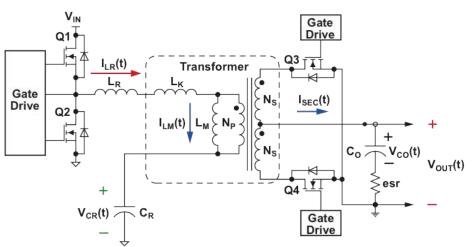


Mode State Sequence:  $1 \rightarrow 3 \rightarrow 5 \rightarrow 6$ 

State	Q1	Q2	Q3	Q4
1	ON	OFF	OFF	ON
2	ON	OFF	ON	OFF
3	ON	OFF	OFF	OFF
4	OFF	ON	OFF	ON
5	OFF	ON	ON	OFF
6	OFF	ON	OFF	OFF

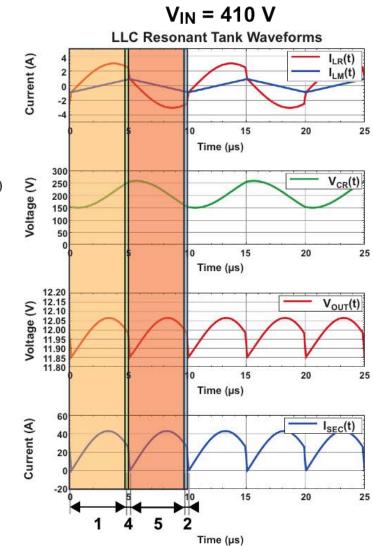


#### **Mode: Resonance**

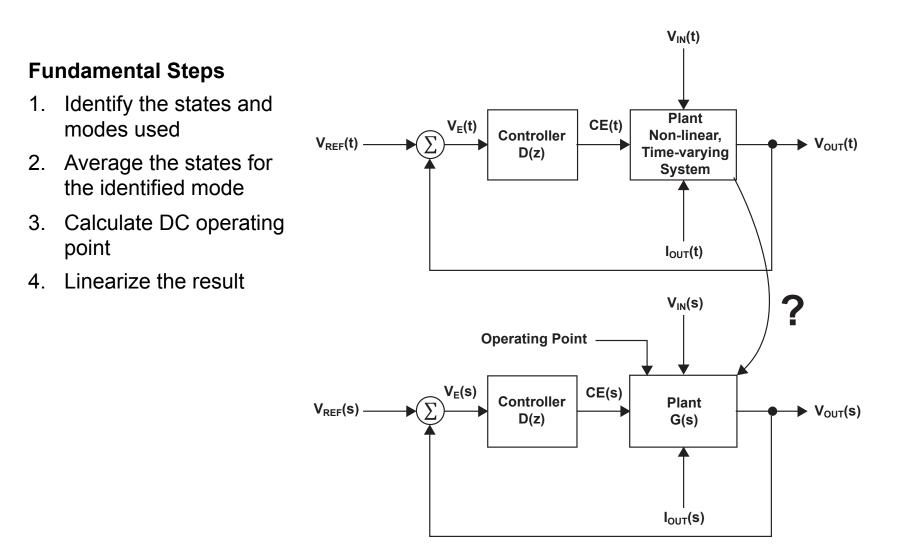


#### Mode State Sequence: $1 \rightarrow 4 \rightarrow 5 \rightarrow 2$

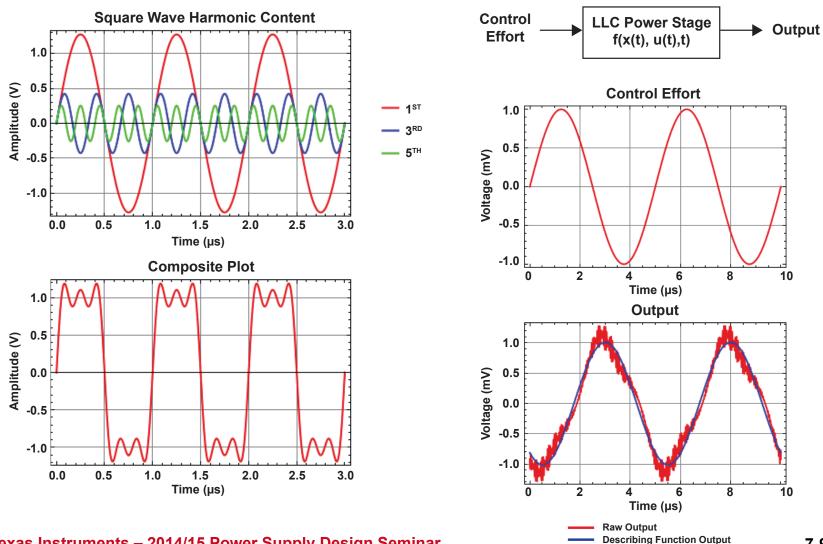
State	Q1	Q2	Q3	Q4
1	ON	OFF	OFF	ON
2	ON	OFF	ON	OFF
3	ON	OFF	OFF	OFF
4	OFF	ON	OFF	ON
5	OFF	ON	ON	OFF
6	OFF	ON	OFF	OFF



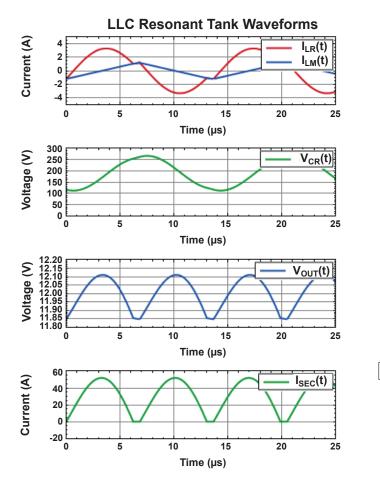
# **Modeling Process Overview**

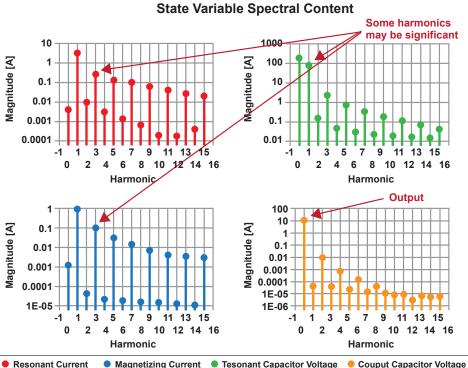


#### **Fourier Series**



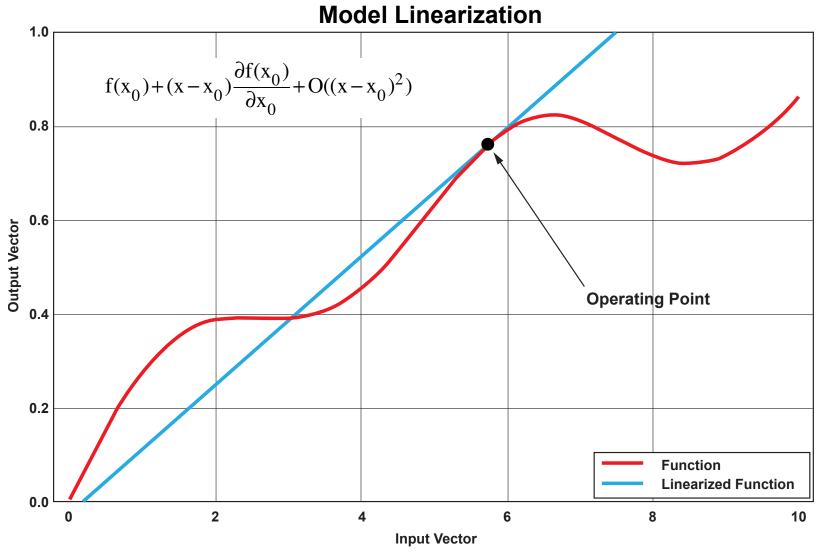
#### **Spectral Considerations**





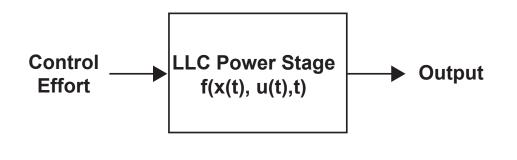
State Variable	Harmonic's Included
I <sub>LR</sub> (t)	1, 3, 5, 7, 9, 11
I <sub>LM</sub> (t)	1, 3, 5, 7
V <sub>CR</sub> (t)	0, 1, 3, 5, 7
V <sub>COUT</sub> (t)	0

#### Linearization



Texas Instruments – 2014/15 Power Supply Design Seminar

#### **Describing Function Analysis**



- Linear System
  - $-\dot{\mathbf{x}}(t) = \mathbf{A} \cdot \mathbf{x}(t) + \mathbf{B} \cdot \mathbf{u}(t)$
  - $y(t) = C \cdot x(t) + D \cdot u(t)$

#### Non-Linear System

$$- \dot{x}(t) = f(x(t) + u(t),t)$$
  
- y(t) = g(x(t) + u(t),t)

$$x^{ss}(t) = X_0^{ss} + \sum_{k=1}^{\infty} \left( X_{ck}^{ss} \cdot \cos(k \cdot \omega_s \cdot t) + X_{ck}^{ss} \cdot \sin(k \cdot \omega_s \cdot t) \right)$$

$$F_{s_k}^{ss} = \frac{2}{T_s} \cdot \sum_{i=1}^{Q} \int_{T_i-1}^{T_i} (A_i \cdot x(t)^{ss} + B_i \cdot U_0) \cdot \sin(k \cdot \omega_s \cdot t) \cdot dt$$

$$F_{c_k}^{ss} = \frac{2}{T_s} \cdot \sum_{i=1}^{Q} \int_{T_i-1}^{T_i} (A_i \cdot x(t)^{ss} + B_i \cdot U_0) \cdot \cos(k \cdot \omega_s \cdot t) \cdot dt$$

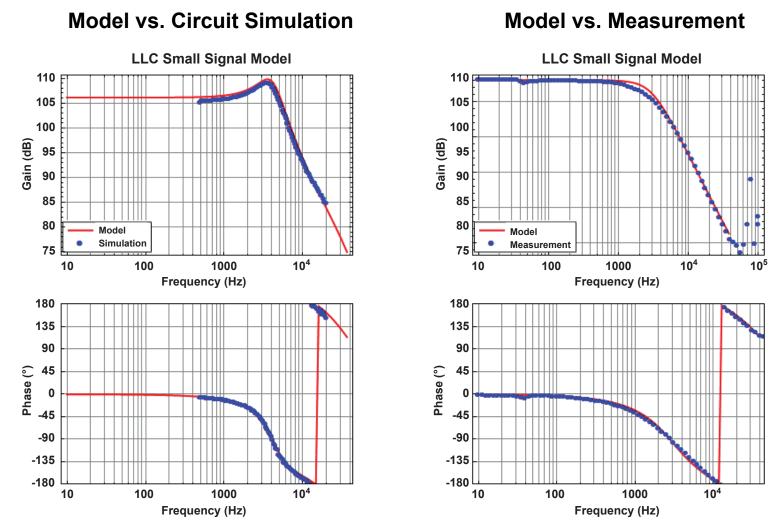
# **Steady State Operating Point**

- LLC +  $C_{OUT} \Rightarrow$  fourth order system
- Piecewise linear simulation:

$$-\dot{x}_{n}(t) = A \cdot x_{n}(t) + B \cdot U$$
$$-x_{n}(t_{i}) = (e^{A \cdot \Delta t} - I) \cdot A^{-1} \cdot B \cdot U + e^{A \cdot \Delta t} \cdot x_{n}(t_{i-1})$$

Lightning fast, highly accurate results

#### **Model Validation**



# **Compensation Objectives**

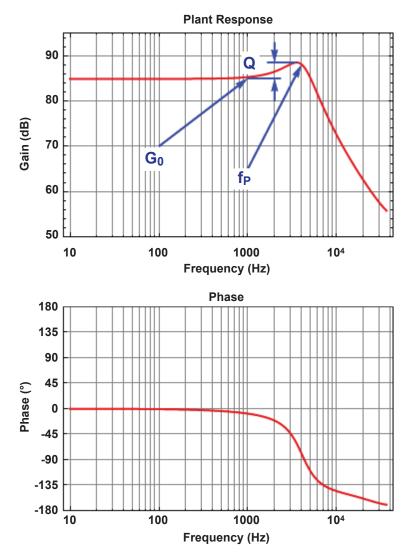
- Stability
  - How do we achieve stability?
  - How do we ensure that we have sufficient stability margin for all operating points?

#### Performance

- Reference tracking
- Load transient response
- Input voltage transient rejection

# **Plant Analysis**

- 4<sup>TH</sup> order system,
  2<sup>ND</sup> order response
  - $G_0 \sim 85 dB$
  - Q ~ 1.35
  - $f_p \sim 4 \text{ kHz}$
- Stability Objectives
  - − Φ<sub>m</sub> ≥ 45 °
    − g<sub>m</sub> ≥ 10 dB



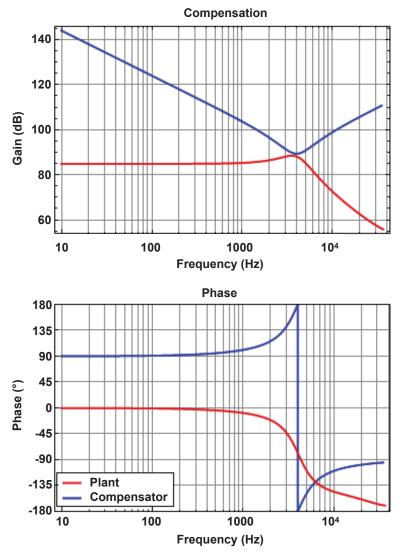
### **Compensation**

$$\mathbf{G}_{0} \cdot \frac{\left(\frac{\mathbf{s}^{2}}{(2 \cdot \boldsymbol{\pi} \cdot \mathbf{f}_{Z})^{2}} + \frac{\mathbf{s}}{2 \cdot \boldsymbol{\pi} \cdot \mathbf{f}_{Z} \cdot \mathbf{Q}_{Z}} + 1\right)}{\mathbf{s}}$$

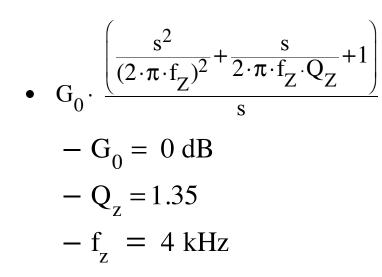
- 1/s term is required to eliminate DC error
- 2 zeros are required for stability

$$- Q_Z = 1.35$$

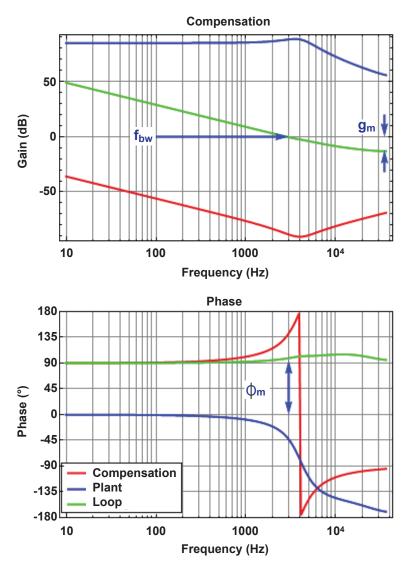
 $- f_z = 4 \text{ kHz}$ 



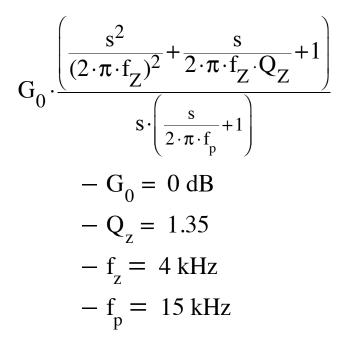
### **Overall Stability**



- Stability Margins
  - $\phi_{m} \cong 95^{\circ}$  $g_{m} \cong 12 \text{ dB}$  $f_{bw} \cong 3 \text{ kHz}$

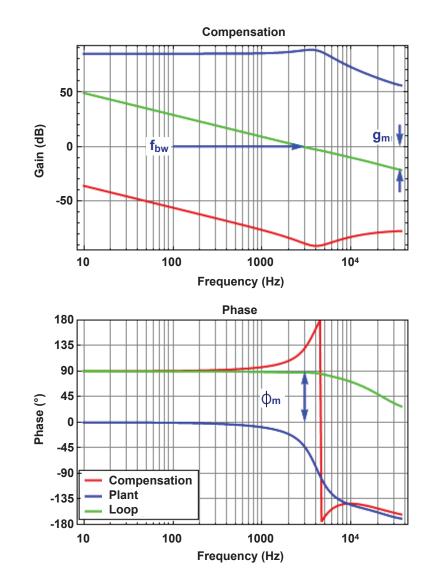


#### **Overall Stability with an Extra Pole**

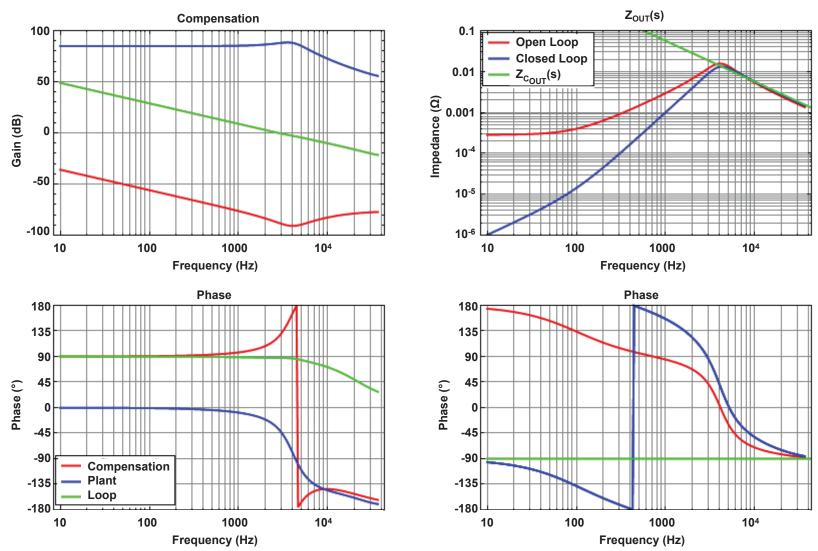


• Stability Margins

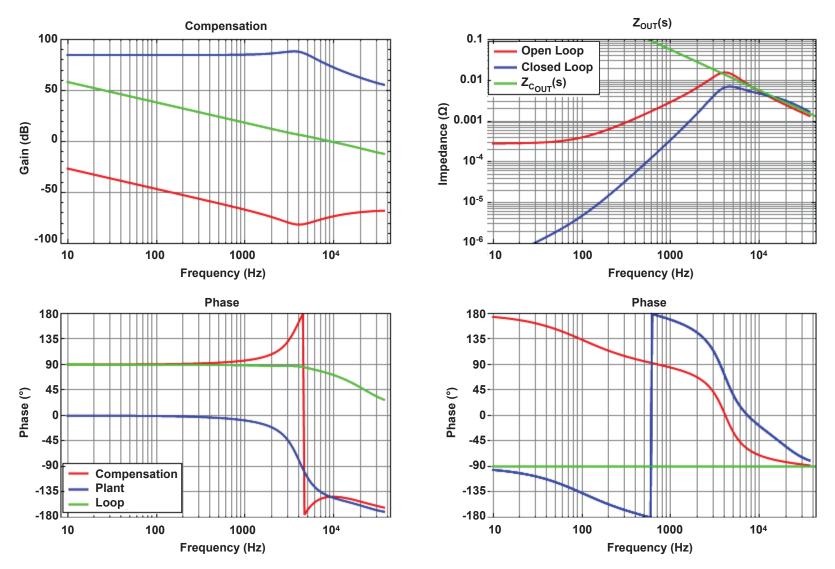
$$- \phi_{m} \cong 90^{\circ}$$
$$- g_{m} \cong 20 \text{ dB}$$
$$- f_{bw} \cong 3 \text{ kHz}$$



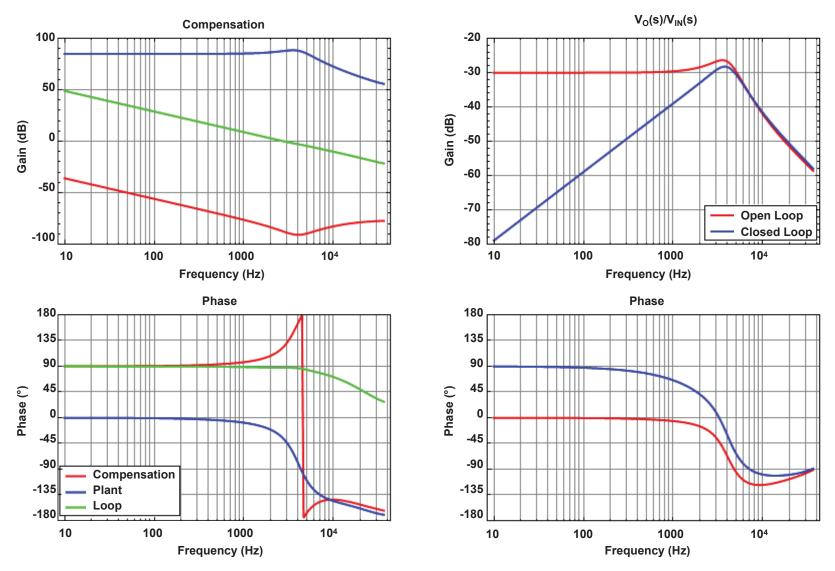
# $Z_{OUT}(s), G_0 = 0 dB$



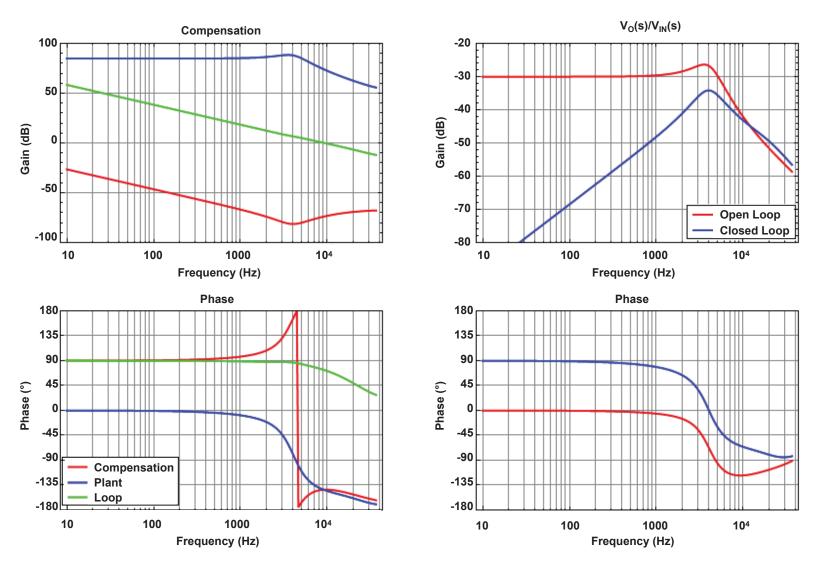
# Z<sub>OUT</sub>(s), G<sub>0</sub> = 9.5 dB



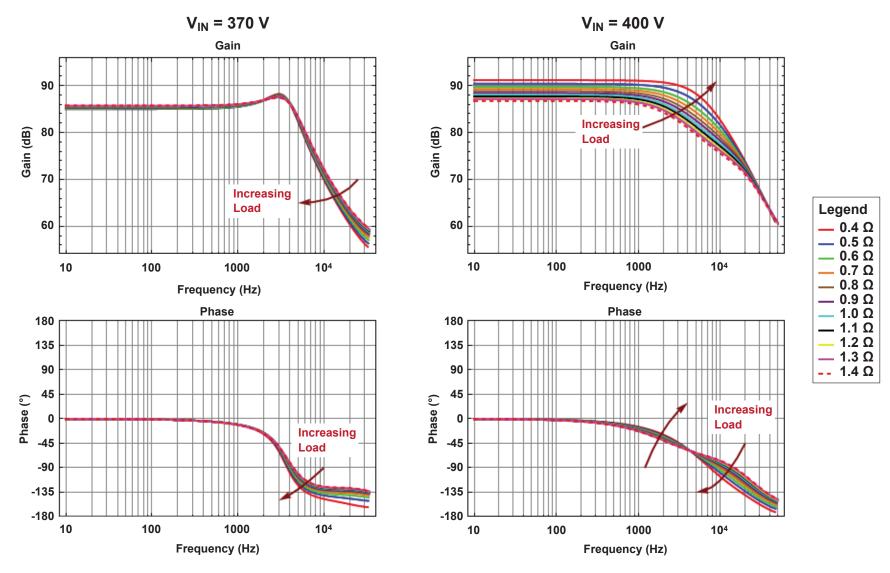
# $\widehat{V}_{OUT}(s)/\widehat{V}_{IN}(s), G_0 = 0 dB$



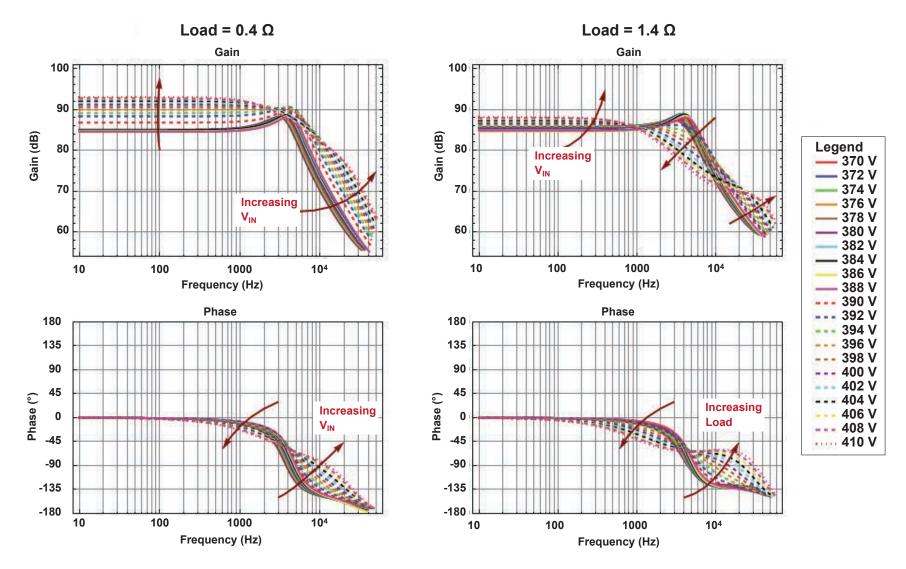
 $\widehat{V}_{OUT}(s)/\widehat{V}_{IN}(s), G_0 = 9.5 \text{ dB}$ 



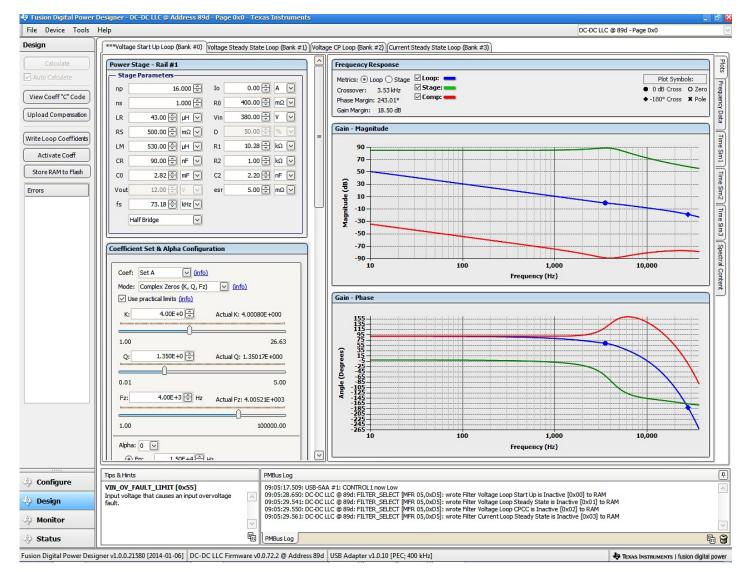
#### **Load Variation**



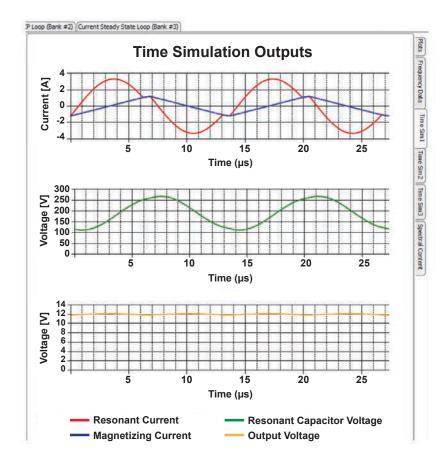
# **V**<sub>IN</sub> Variation

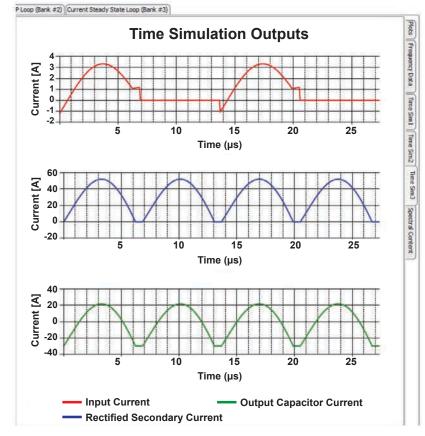


#### **Fusion Digital Power Designer**



#### **Time Domain Behavior**





# Limitations

- Low efficiency scenarios may need additional work to achieve proper correlation
- Does not support PWM or PSM
- Corner cases may exist which limit the accuracy due to numerical approximations
- Additional work may be required to ensure accuracy, especially at higher frequencies

# Conclusions

- Analytical predictions of plant pole zero behavior enables more robust compensation
  - Parameter variations
  - Extreme operating conditions
- Independent validation of the DC operating point
- Instant visualization of:
  - Key system waveforms
  - Harmonic content
- Seamless integration with TI standard isolated digital controllers

# **Future Work**

- DC operating point
- Performance metrics
  - $Z_{OUT}(s)$
  - $Z_{IN}(s) \widehat{V}_{OUT}(s) / \widehat{V}_{IN}(s)$
- Modulation methods
  - FM
  - PSM
  - PWM

- Additional States & Modes
  - Switching transitions
  - Body diode conduction

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